

Chapter 9. Assembly and Consolidation of Nanoparticles

9.1 Introduction

** Use of nanoparticles*

- *Dispersed state: paints, filler, cosmetics, homogenous or dispersed catalysts*
- *Consolidated state*
 - *porous: catalysts, sensor, electrodes(directly, or indirectly)*
 - *densified: ultrahard alloy, fine ceramics, ceramic engines*
 - *ordered: electronic, optical, optoelectronic devices*

** Consolidation:*

- *size enlargement of nanoparticles*

** Methods of consolidation*

- *forming by using templates usually*

3-D: die casting, extrusion, spray drying

2-D: deposition on substrate surface

*1-D: use of linear template, particle dipoles**

* *Source of consolidation*

Particle-to-particle interaction or particle-to-substrate interaction

- *Long-range force for consolidation*

- *Brownian motion*

- *capillary force*

- *fluid force (inertia, shear)*

- *external force (electrical, pressure, gravitational)*

- *Ultimate consolidation (short-range force)*

- *van der Waals' force*

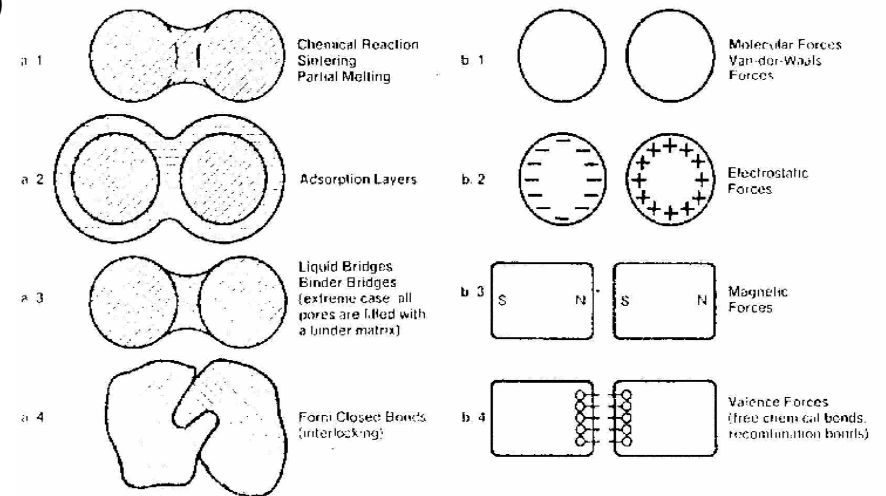
- *liquid bridge*

- *chemical bond*

(usually via surface modifier)

* *Ultimate densification*

- *Sintering*



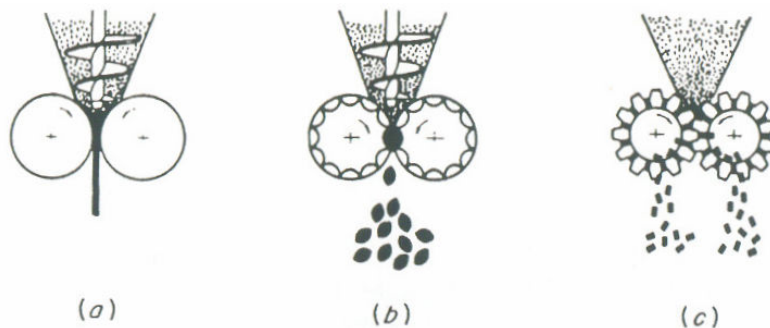
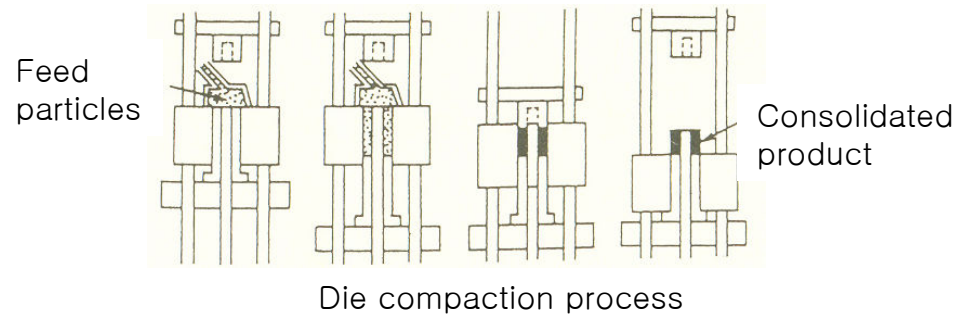
9.2 Mechanical Forming

(1) Pressure forming

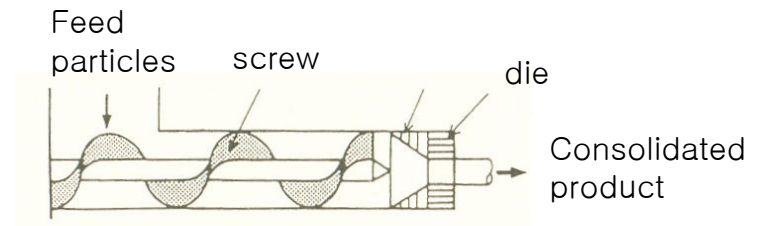
- Pressing of masses through openings of sieves, rollers, or dies
- Solid bridges : formed by compressive deformation at the point of contact
- Dry or moist binder and lubricants : used for powders which are difficult for compaction

* Methods

- Die compaction
- Roll compaction
- Extrusion



Roller, a:compaction; b:briquetting; (c) pelleting



Extruder

(2) Granulation

* Granulation process:

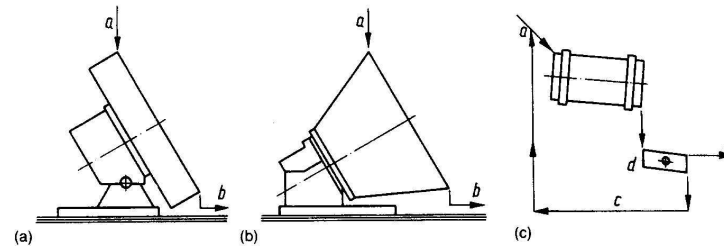
wetting → growth → granule consolidation

nucleation/coalescence/layering

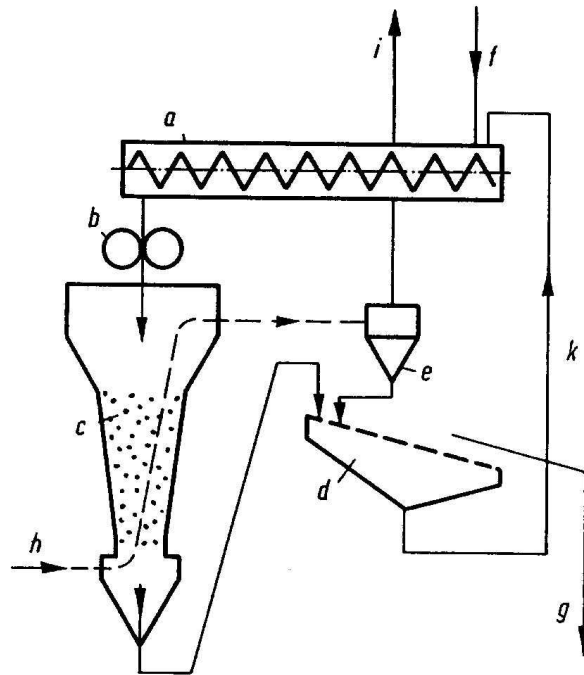
- *Interparticle collision by tumbling, mixing and turbulent motion*
- *Often requires moisture or other binding agents*
- *Not very strong agglomeration without after-treatment (drying, sintering)*

* Methods of granulation

- *Tumbling type*
- *Agitation type*
- *Fluidization type*



Tumbling-type granulators (a) disc (b) cone (c) drum
a.Feed+water(binder); b.green agglomerates; c.recycle
a.Feed+water(binder); b.green agglomerates; c.recycle
(undersize); d.sieve



Fluidized-bed granulator

a.mixing screw, b.distributing rolls, c.venturi fluidizer, d.sieve,
 e.cyclone, f.feed, g.granulates, h.hot gas, i.exhaust air,
 k.recycled undersize

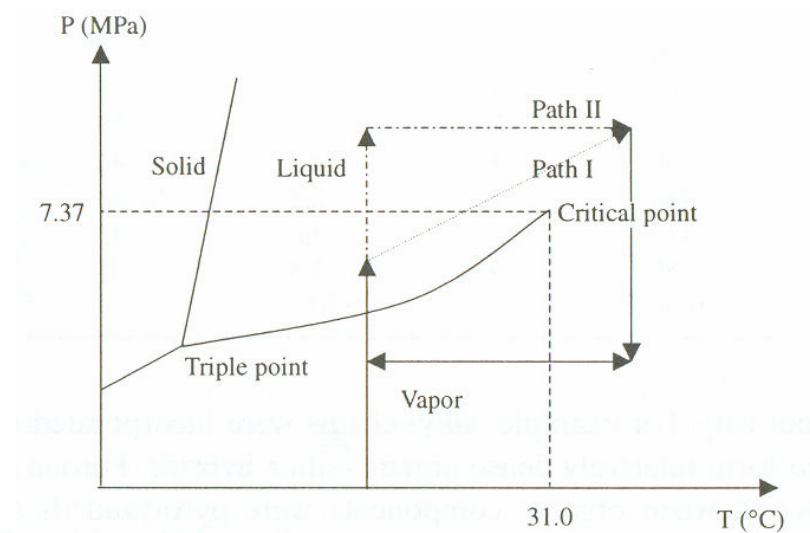
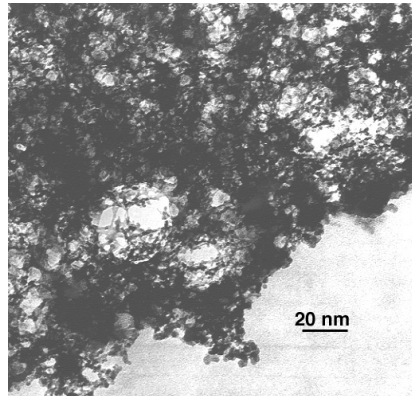
9.3 Porous Structure Materials by Sol-gel-drying Processes

(1) Aerogels and xerogels

* Drying

- due to capillary force in the pores $p_c = -\sigma_{lv} \cos \theta \left(\frac{1}{R_1} + \frac{1}{R_2} \right)$
 under ambient conditions \rightarrow collapsed dried gel \rightarrow xerogel

* Supercritical drying \rightarrow aerogels



- Critical points

Solvents	Formula	T_c (°C)	P_c (MPa)
Water	H ₂ O	374.1	22.04
Carbon dioxide	CO ₂	31.0	7.37
Freon 116	(CF ₃) ₂	19.7	2.97
Acetone	(CH ₃) ₂ O	235.0	4.66
Nitrous oxide	N ₂ O	36.4	7.24
Methanol	CH ₃ OH	239.4	8.09
Ethanol	C ₂ H ₅ OH	243.0	6.3

- *Solvent exchange*

- *Characteristics of aerogels*

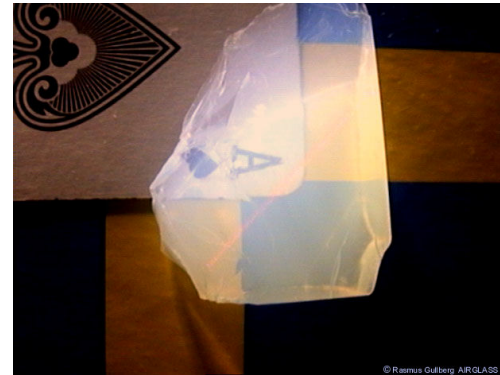
Porosity: 75-99%

Specific surface area: $\sim >1,000\text{m}^2/\text{g}$

cf. porosity of xerogel: 1-50%

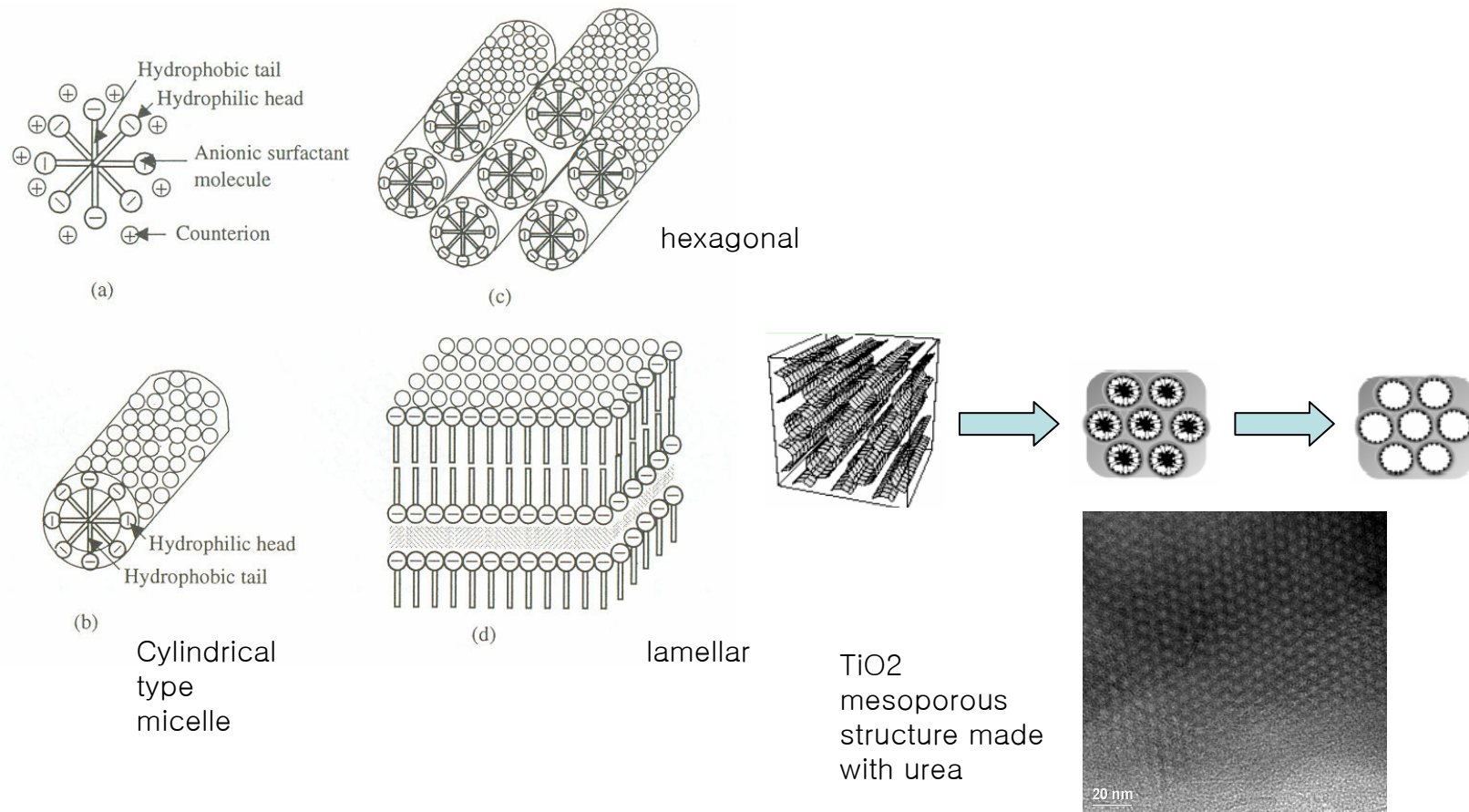
- *very light, transparent*

- *used in catalysts, sensor, electrodes, thermally and/or electrically insulating materials*



(2) Mesoporous materials

- starting from precursor + solvent + catalyst + surfactant
- aligning surfactant molecules during solvent evaporation
- hydrolysis and condensation like sol-gel process on head side of the alignment



(3) Sol-derived films

- simultaneous evaporation and gel formation*
- crack formation possible by rapid drying and incompatibility between coating and substrate*

Spin coating

- delivery of sol onto the substrate center → spin-up → spin-off → evaporation*
- Uniform films for Newtonian fluid*
- Thickness*

$$H = \left(1 - \frac{\rho_A^0}{\rho_A} \right) \left(\frac{3\mu e}{2\rho_A^0 \omega^2} \right)$$

where ρ_A , ρ_A^0 present and initial mass of volatile solvent per unit volume

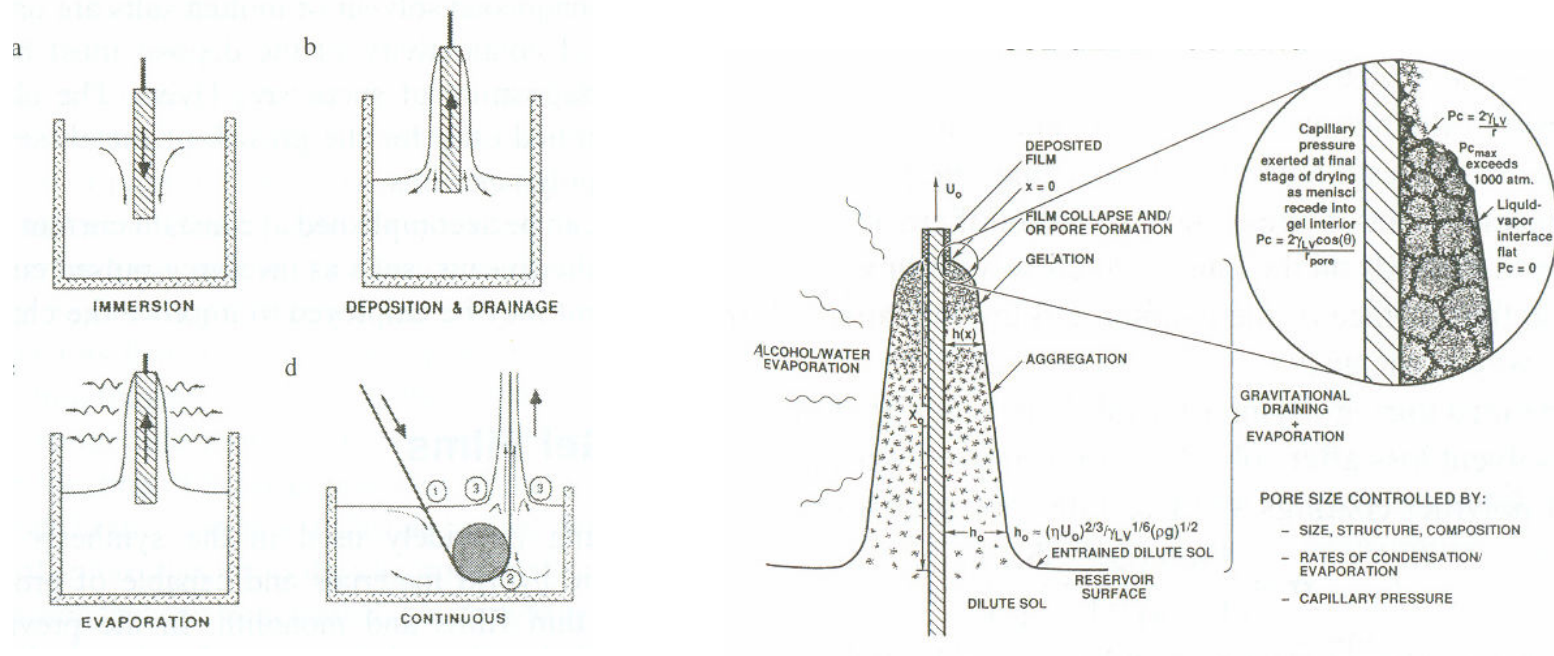
μ : viscosity of liquid

e : evaporation rate

ω : angular velocity

Dip coating

- evaporation and gel formation



- thickness

$$H = c_1 \left(\frac{\mu U_0}{\rho g} \right)^{1/2}$$

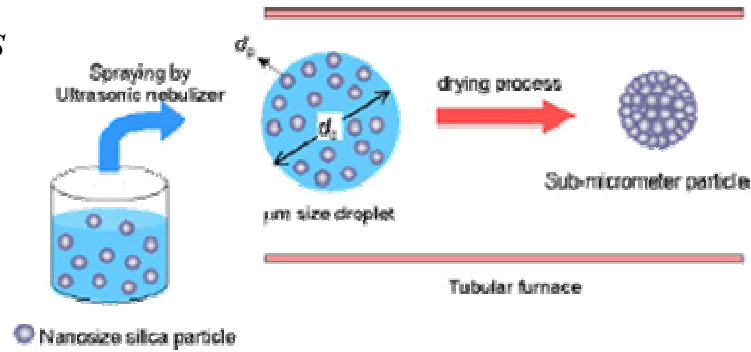
where U_0 : withdrawal speed of the substrate

ρ : density of coating

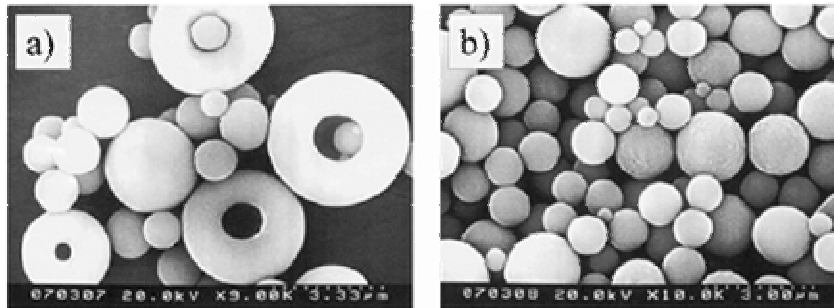
c_1 : constant

9.4 Sol spray drying method

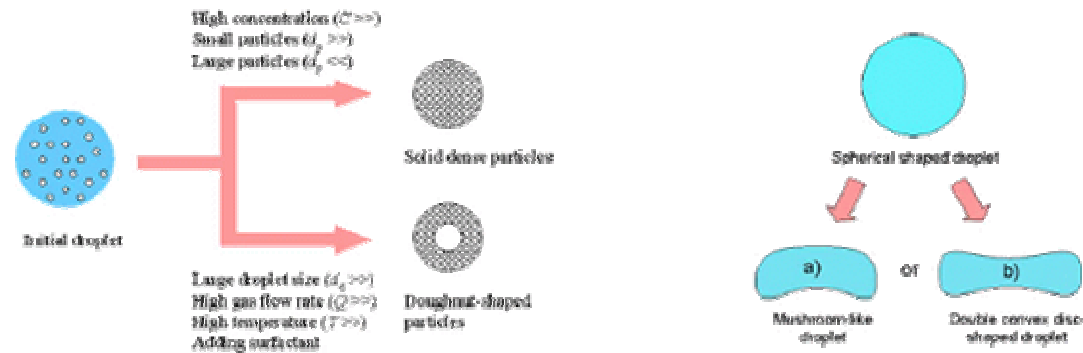
(1) Spherical porous materials



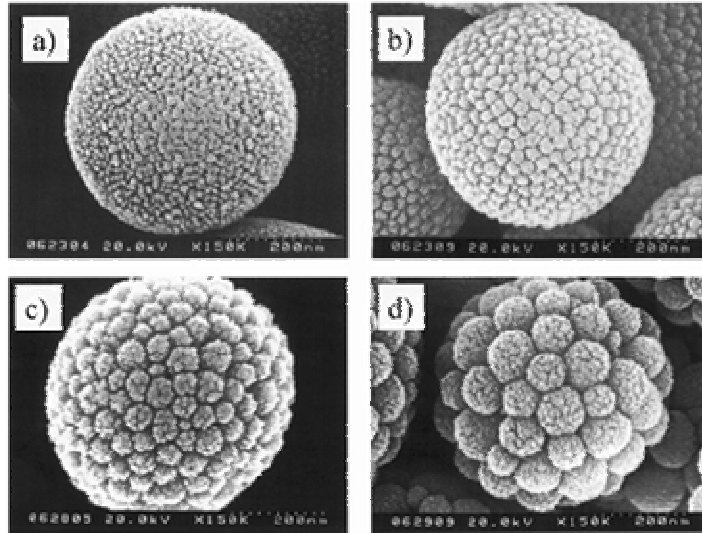
- Morphology of dried aggregates



SEM photographs of dried silica particles obtained without (a) and with (b) diffusion dryer placed before reactor inlet.



- Hierarchical structures



Effect of primary particle size on morphology of final particles. Experimental condition: (a) CS-1, (b) CS-2, (c) CS-3 and (d) CS-4, at 200.C.

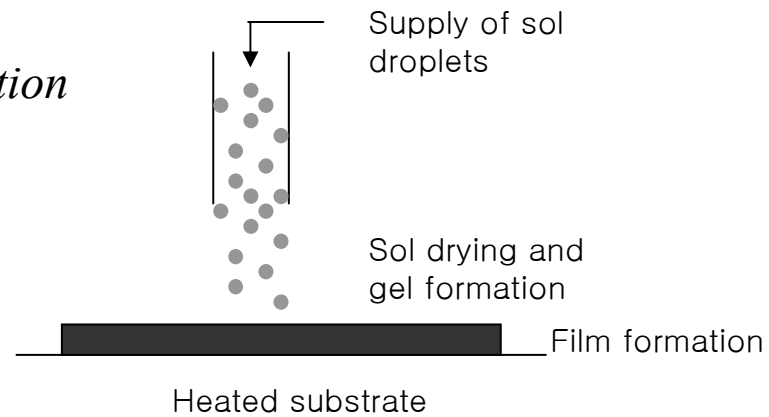
Physical properties of colloidal silica suspension

Sample	Nominal particle diameter, d_p (nm)	Suspension pH
CS-1	4-6	9-10
CS-2	20-30	8.5-9.5
CS-3	40-60	9-10
CS-4	70-100	9-10

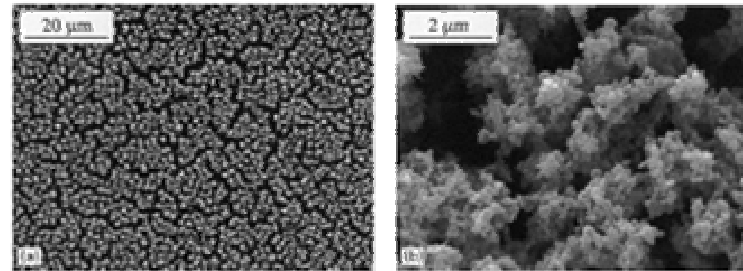
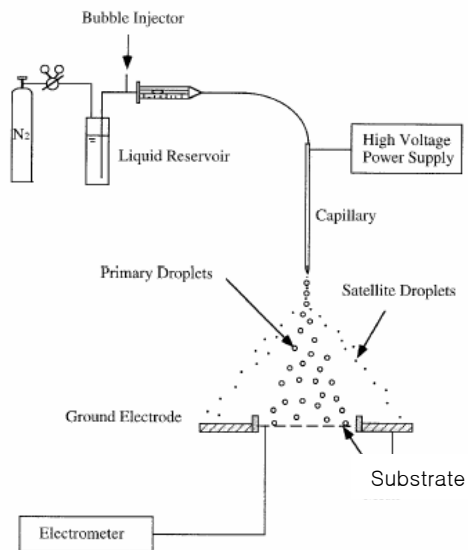
- Also produces mesoporous structures

(2) Sol-spray deposition

- Ordinary spray deposition



- Electrospray deposition

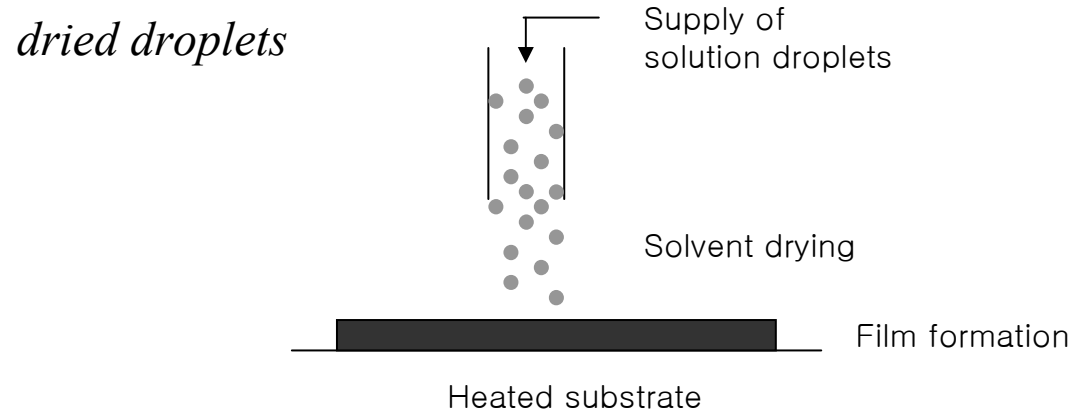


SEM micrographs (with two magnifications) of a ZrO_2 thin film deposited at $220^\circ C$ on an Al plate substrate (flow rate: 0.8 ml/h)

- enhancement of deposition efficiency

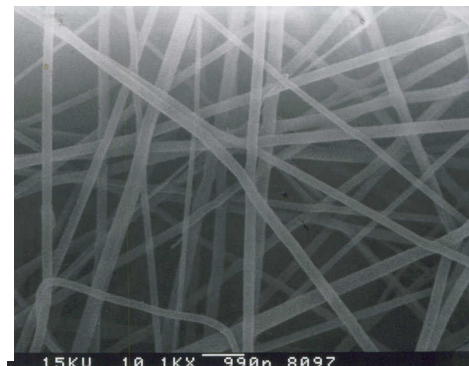
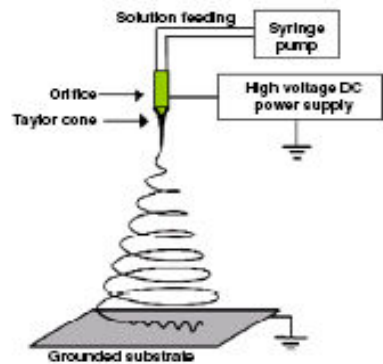
(3) Chemical aerosol deposition

- *spray* → *solvent evaporation* → *deposition*
- *deposition occurred mainly by diffusion of solute molecules and/or partially*

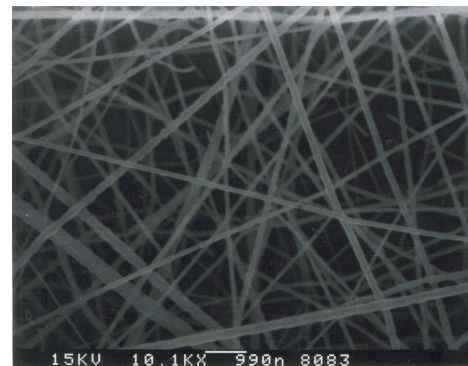


(4) Electrospinning

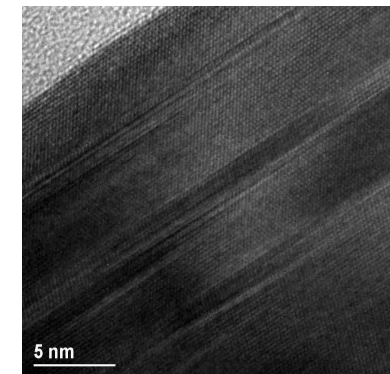
- *electrospray of linear polymer+ precursor solution followed by calcination*



Before calcination



After calcination



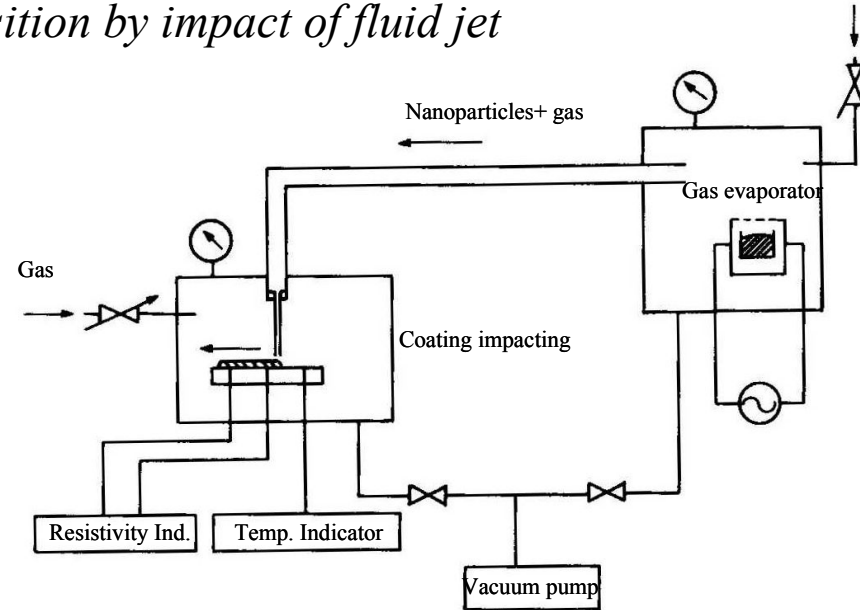
9.5 Direct deposition in fluid

(1) Electrophoresis of sols

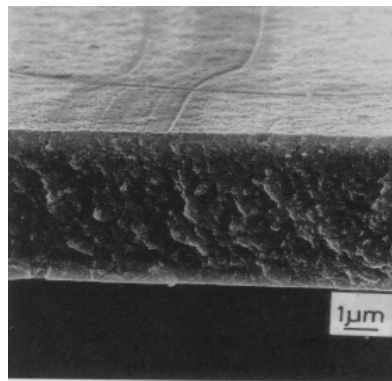
- Movement of surface charged particles*
- packing density <74%*
- depends on particle concentration, zeta potential, applied electric field*
- slow arrival of nanoparticles onto the surface results in high packing density...*

(2) *Impaction of nanoparticle beams*

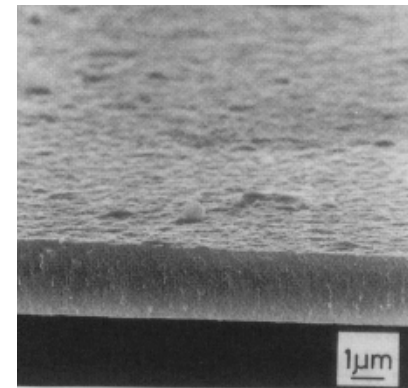
- *particle deposition by impact of fluid jet*



- *use of vacuum*

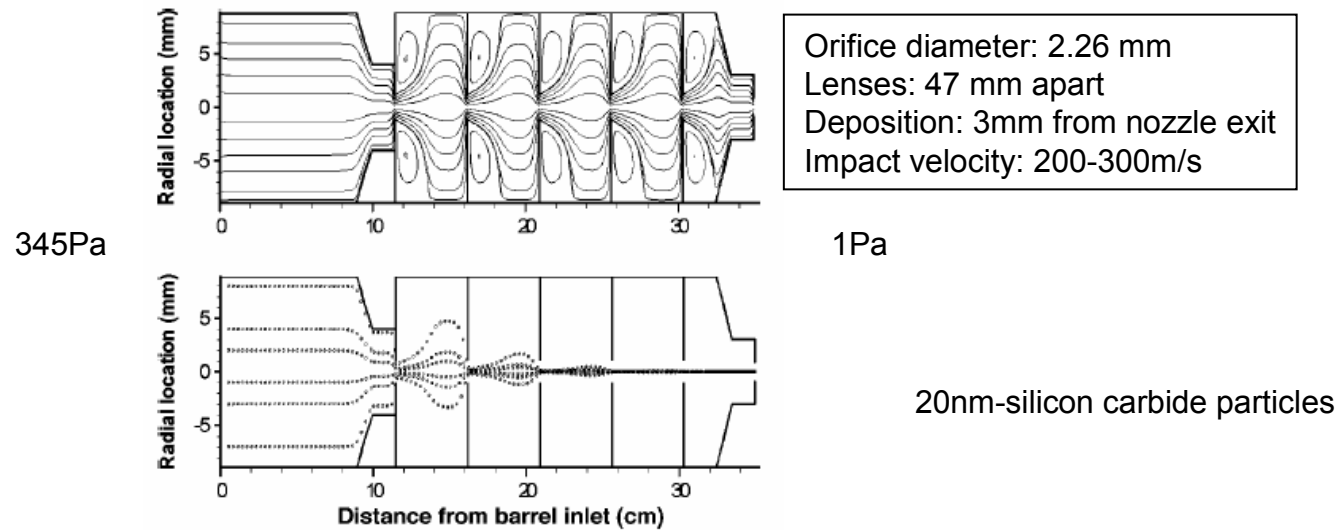


Ag film



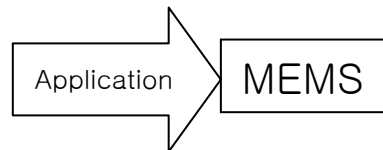
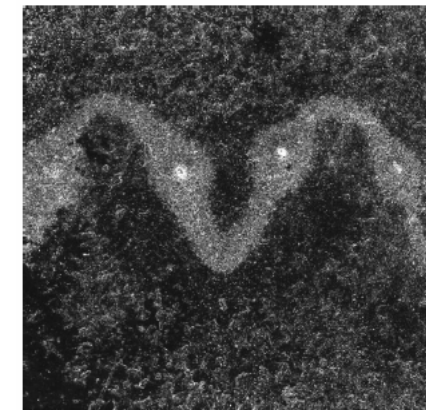
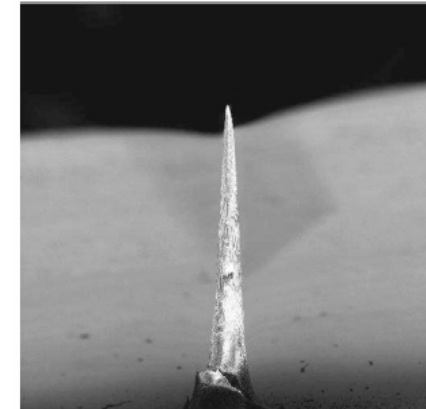
Cu film

- Cascade hypersonic impactors

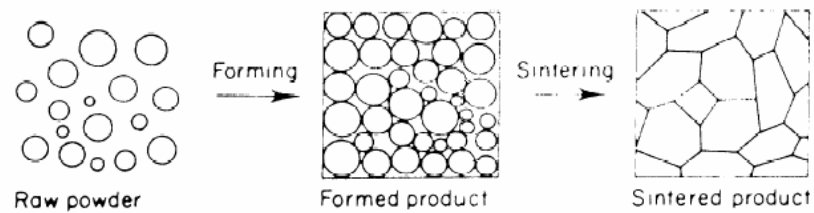


Predicted flow streamlines (top) and particle trajectories (bottom) in the aerodynamic lens assembly.

F. Di Fonzo, A. Gidwani, M. H. Fan, D. Neumann, D. I. Iordanoglou, J. V. R. Heberlein, P. H. McMurry, and S. L. Girshicka), N. Tymiak and W. W. Gerberich, and N. P. Rao, Appl. Phys. Lett., Vol. 77, No. 6, 7 August 2000



9.6 Formation of dense structure: sintering



* *Driving force of sintering:*

- *Reduction in overall surface energy :Reduction in surface area relative to its volume*

* *Four stages of sintering*

Stage	Process	Surface Area Loss	Densification	Coarsening
Adhesion	Contact formation	Minimal, unless compacted at high pressures	None	None
Initial	Neck growth	Significant, up to 50% loss	Small at first	Minimal
Intermediate	Pore rounding and elongation	Near total loss of open porosity	Significant	Increase in grain size and pore size
Final	Pore closure, final densification	Negligible further loss	Slow and relatively minimal	Extensive grain and pore growth

(1) Mechanism of sintering

- *Surface transport: neck growth without shrinkage or densification*

$$\frac{\Delta l}{l} = 0$$

where Δl : increase in length of particle

l: initial length of particle

- *surface diffusion: lowest activation energy, predominant at low temperature*
- *vapor diffusion: evaporation from convex surface to concave surface*
- *bulk transport: net particle movement leading to shrinkage and densification*

Accompanying shrinkage in dimension

- ***lattice** diffusion: dominant for crystalline materials*
 - ***cross grain boundary** diffusion: dominant for crystalline materials*
 - ***viscous flow**: dominant for amorphous materials*
- * Reactive sintering: solid-to-solid (solid phase) reaction*
- *Formation of interface product layer*

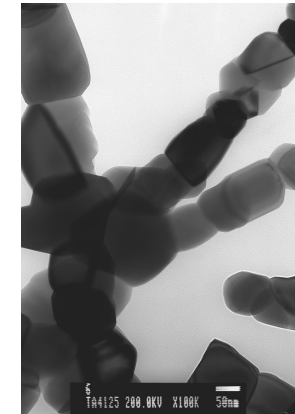
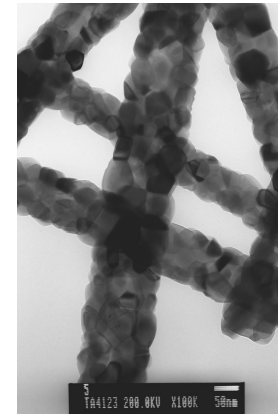
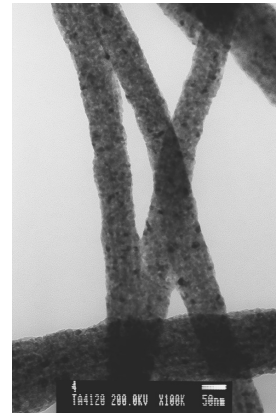
e.g. Pozzolanic reaction : $\text{SiO}_2 + \text{Ca(OH)}_2$ in water at elevated pressure

(2) *Sintering of nanoparticles*

* *Advantages of nanoparticle sintering*

- ***High rate of sintering***
- ***Lowering of sintering temperature***
- ***Addition of nanoparticles accelerates the sintering of larger particles***

e.g. W+ 0.1-0.5% of Ni nanoparticles; sintering temperature to 1200~1300°C.



Sintering of TiO₂ nanofiber with respect to temperature

From left to right: 400, 600, 800°C

* *Disadvantages of nanoparticle sintering*

- ***Aggregation*** results in formation of pores, change in required dimension or deformation of the sintered body.

☞ *High-pressure sintering/ Fast-firing/ Plasma-assisted sintering*

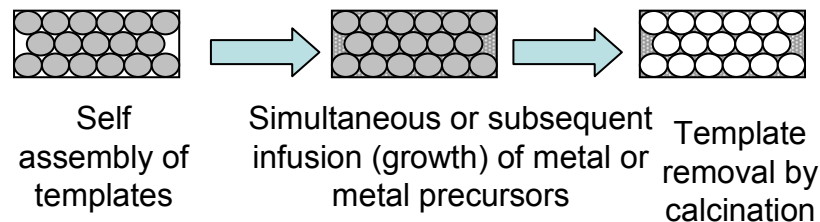
Chemical modification of the nanoparticle surface

9.7 Ordered consolidation by self assembly

Self assembly: a process by which components spontaneously assemble without the requirement of external energy or information

(1) Building blocks

- Ordinary sols
- Monolayer protected (passivated) nanoparticles
 - alkanethiol
 - sulfide or sulfur containing biomaterials (DNA, proteins)
 - Assembly: used for electronic, optoelectronic devices, biological chips...
- Colloidal crystals (>100nm)
 - Monodisperse submicron particles (silica, latex)
 - Assembly: used for photonic crystals, catalysts, sensors, electrodes...



(2) 1-D assembly

Pore filling

* *Ordered pores*

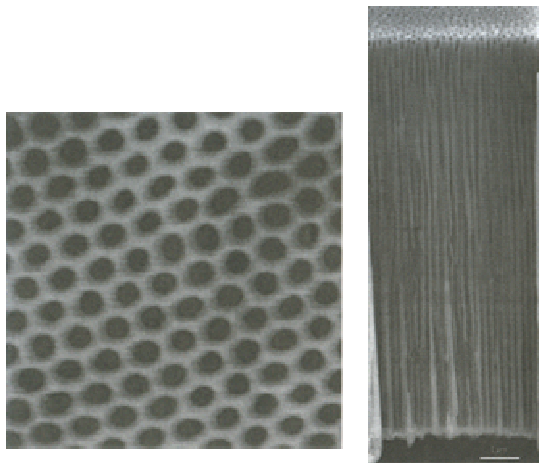
- *Anodized aluminum membrane*

made by anodic oxidation of aluminum sheet in acid solutions...

- *Capillary membranes: polycarbonate films bombarded by neutron beams*

* *Filling: capillary force, electrophoresis, pressure, chemical vapor deposition, centrifugation*

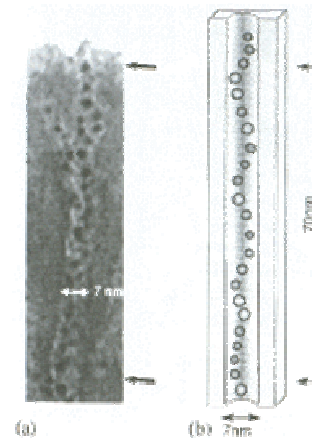
- *high wettability, chemical inertness against pore wall, shrinkage control*



Alumina surface anodized in acids



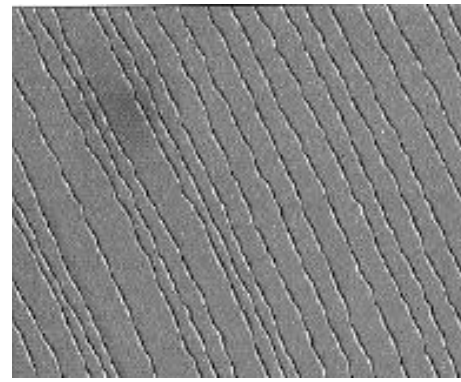
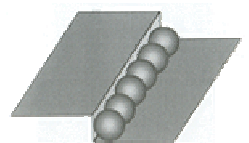
TiO₂ nanowires from its sol-alumina removed



Wire of surface-modified Au₅₅ particles d=4.2nm

Deposition or attachment onto existing line templates

- Along line defect
 - Defined steps on crystalline surfaces
- Existing nanowires
- Linear polymers

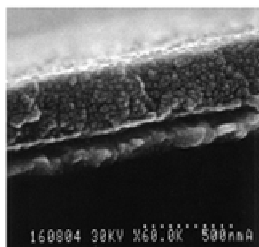


Copper wire 3nmwide and 50nm apart on a stepped Mo(110) surface–STM

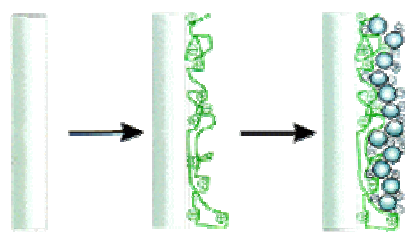
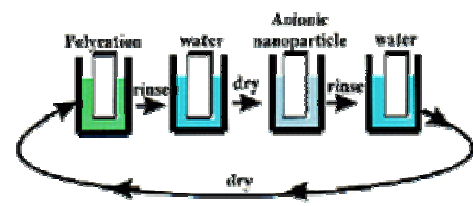
(3) 2-D assembly

* Deposition of building blocks by

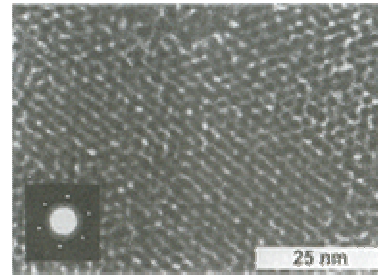
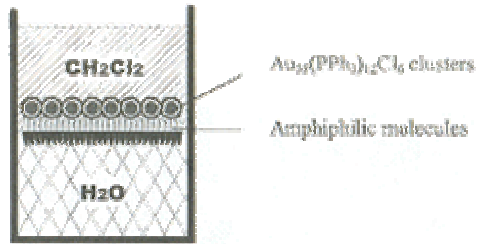
- Electrophoresis
- Electrostatic force



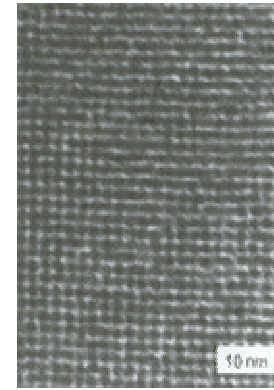
SnO₂ self-assembled nanoparticles – gas sensor



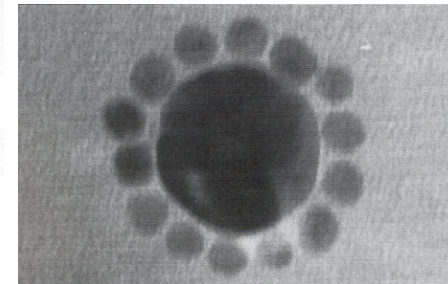
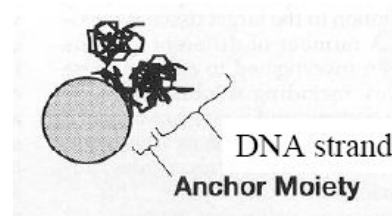
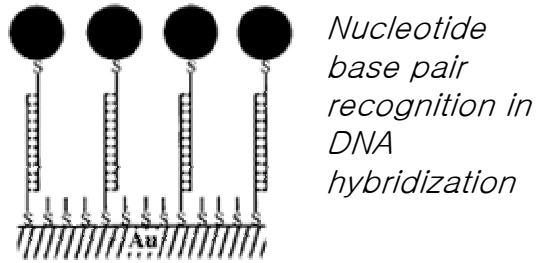
- Bond linkage



Hexagonal monolayer on Poly(vinylpyrrolidone)



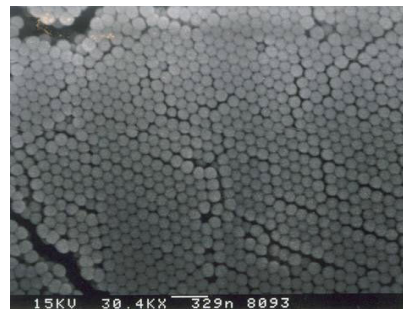
Arranged squares on poly(ethyleneimine)



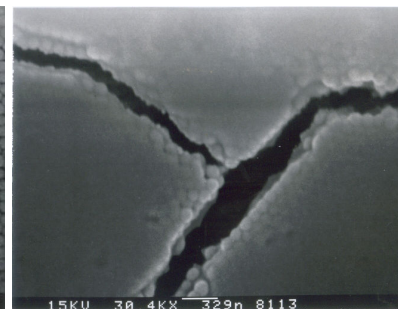
30nm-gold particle linked with 8-nm gold particles via DNA linkage

- Gravity filtration

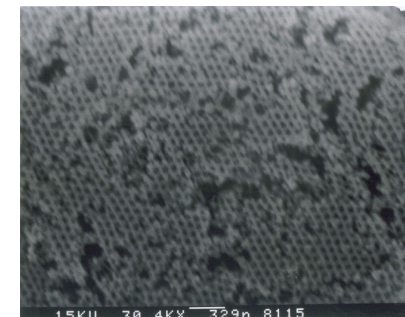
- Dip coating



Dip coating of polystyrene latexes

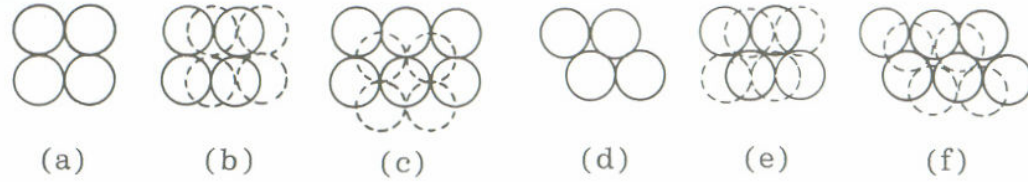


TTIP dip-coating



After calcination

* *Regular packing of equal spheres*



Types of packing	Figures	Volume of unit cell	Void volume of unit cell	Void fraction	Packing fraction	Coordination number
Cubic	(a)	D_p^3	$0.48D_p^3$	0.4764	0.5236	6
Orthorhombic	(b), (d)	$0.87D_p^3$	$0.34D_p^3$	0.3954	0.6046	8
Tetragonal-sphenoidal	(e)	$0.75D_p^3$	$0.23D_p^3$	0.3019	0.6981	10
Rhombohedral	(c), (f)	$0.41D_p^3$	$0.18D_p^3$	0.2595	0.7405	12

D_p , diameter of equal spheres.